

# STARPOWER

SEMICONDUCTOR

# MOSFET

## MD85HFS120L2S\_B11

**1200V/8.5 mΩ 2 in one-package**

### General Description

STARPOWER MOSFET Power Module provides very low  $R_{DS(on)}$  as well as optimized intrinsic diode. It's designed for the applications such hybrid electrical vehicles.

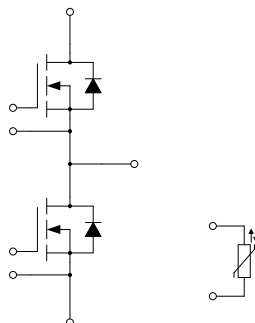
### Features

- SiC power MOSFET
- Low  $R_{DS(on)}$
- Optimized intrinsic reverse diode
- Avalanche ruggedness
- Low inductance case
- Substrate for low thermal resistance
- Isolated heatsink using AlN DBC technology

### Typical Applications

- Automotive applications
- Auxiliary inverters
- DC/DC converter
- Hybrid electrical vehicles(H)EV

### Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**MOSFET**

Symbol	Description	Value	Unit
$V_{DSS}$	Drain-Source Voltage	1200	V
$V_{GSSmax}$	Gate-Source Voltage	-8/+19	V
$V_{GSSop}$	Gate-Source Voltage	-4/+15	V
$I_D$	Drain Current @ $T_C=25^{\circ}\text{C}$	230	A
$I_{DRM}$	Repetitive Peak Drain Current tp limited by $T_{vjop}$	460	A
$P_D$	Maximum Power Dissipation @ $T_{vj}=175^{\circ}\text{C}$	1014	W

**Body Diode**

Symbol	Description	Value	Unit
$I_S$	Source Current @ $T_C=25^{\circ}\text{C}$	170	A

**Module**

Symbol	Description	Value	Unit
$T_{vjmax}$	Maximum Junction Temperature	175	$^{\circ}\text{C}$
$T_{vjop}$	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	2500	V

**MOSFET Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$R_{DS(on)}$	Static Drain-Source On-Resistance	$I_D=150\text{A}, V_{GS}=15\text{V}, T_{vj}=25^\circ\text{C}$		8.50		m $\Omega$
		$I_D=150\text{A}, V_{GS}=15\text{V}, T_{vj}=150^\circ\text{C}$		13.6		
		$I_D=150\text{A}, V_{GS}=15\text{V}, T_{vj}=175^\circ\text{C}$		14.3		
$V_{GS(th)}$	Gate-Source Threshold Voltage	$I_D=41.7\text{mA}, V_{DS}=V_{GS}, T_{vj}=25^\circ\text{C}$		2.6		V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=V_{DSS}, V_{GS}=0\text{V}, T_{vj}=25^\circ\text{C}$			500	$\mu\text{A}$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=19\text{V}, V_{DS}=0\text{V}, T_{vj}=25^\circ\text{C}$			600	nA
$R_{Gint}$	Internal Gate Resistance			1.0		$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=1000\text{V}, f=100\text{kHz}$		13.1		nF
$C_{oss}$	Output Capacitance			0.43		nF
$C_{rss}$	Reverse Transfer Capacitance			0.02		nF
$Q_g$	Total Gate Charge	$I_D=150\text{A}, V_{DS}=800\text{V}, V_{GS}=-4/+15\text{V}$		0.38		$\mu\text{C}$

**Body Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{SD}$	Diode Forward Voltage	$I_{SD}=76\text{A}, V_{GS}=-4\text{V}, T_{vj}=25^\circ\text{C}$		4.35		V
		$I_{SD}=76\text{A}, V_{GS}=-4\text{V}, T_{vj}=175^\circ\text{C}$		3.80		

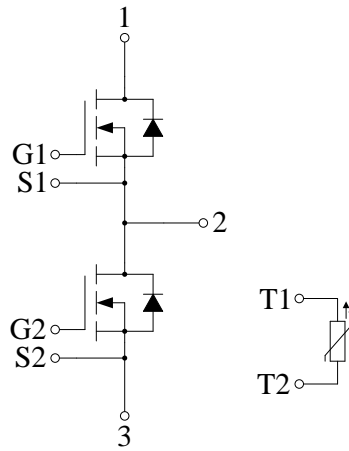
**NTC Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$R_{25}$	Rated Resistance			5.0		k $\Omega$
$\Delta R/R$	Deviation of $R_{100}$	$T_1=100^\circ\text{C}, R_{100}=493.3\Omega$	-5		5	%
$P_{25}$	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$		3411		K
$B_{25/100}$	B-value	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$		3433		K

**Module Characteristics**  $T_c=25^{\circ}\text{C}$  unless otherwise noted

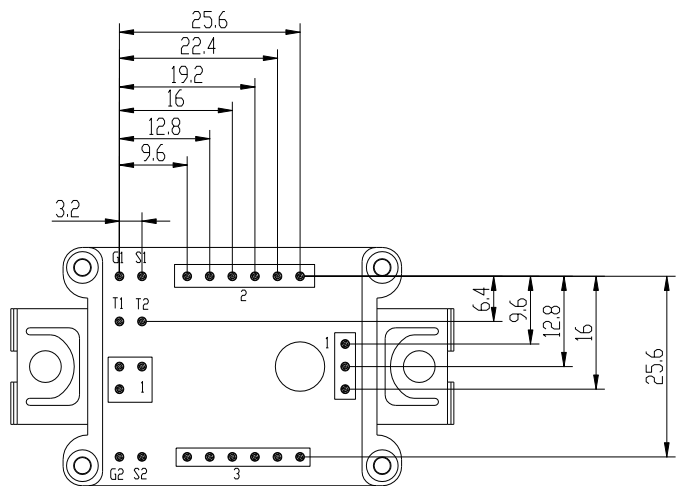
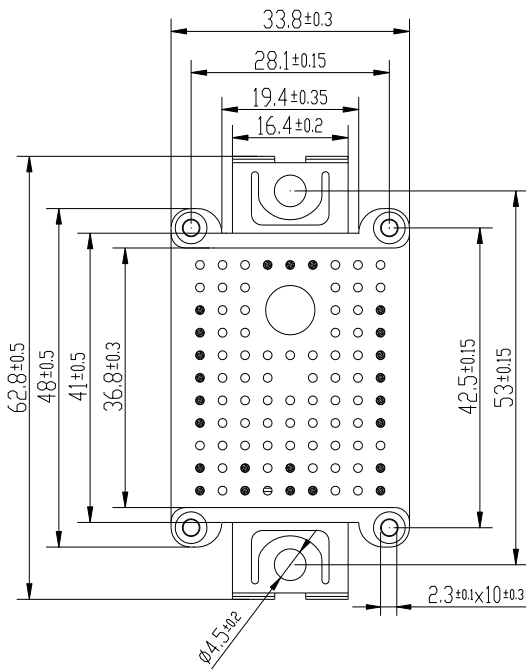
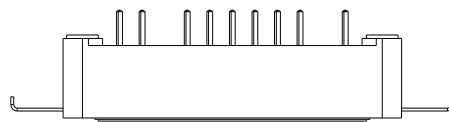
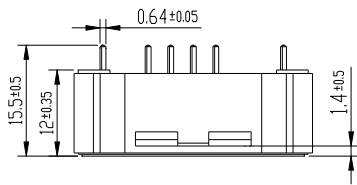
Symbol	Parameter	Min.	Typ.	Max.	Unit
$R_{thJC}$	Junction-to-Case (per MOSFET)		0.135	0.148	K/W
$R_{thCH}$	Case-to-Heatsink (per MOSFET)		0.116		K/W
	Case-to-Heatsink (per Module)		0.058		
F	Mounting Force Per Clamp	20		50	N
G	Weight of Module		24		g

### Circuit Schematic



### Package Dimensions

Dimensions in Millimeters



Pinpositions with tolerance  $\Phi 0.1$

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